Mail Stop: Assignment Recordation Services RECORDATION FORM Director of the U.S. Patent PATENTS C and Trademark Office P.O. Box 1450							
Alexandria, VA 22313-1450	Attorney Docket No. 148406						
Please record the attached document,							
Total number of pages including cover sheet, attachments, and docume	ent: <u>2</u>						
1. A. Name of conveying parties: (1) Yoshitaka SASAKI (2) Hiroyuki ITO (3) Hiroshi IKEJIMA (4) Atsushi IIJIMA B. Additional name(s) of conveying party(ies) attached? □ Yes ☑ No	2. A. Name and address of receiving party: (1) HEADWAY TECHNOLOGIES, INC. 678 S. HILLVIEW DR., MILPITAS, CA 95035 U.S.A. (2) SAE MAGNETICS (H.K.) LTD. SAE TECHNOLOGY CENTRE, 6 SCIENCE PARK EAST AVENUE, HONG KONG SCIENCE PARK, SHATIN, N.T., HONG KONG, CHINA						
3. A. Nature of conveyance:	B. Additional name(s) & address(es) attached? ☐ Yes ☑ No						
Other							
B. Execution Date: <u>(1 and 2): May 16, 2011:</u> (3 and 4): May 20, 2011							
4. A. Patent Application No. <u>13/014,418</u>	B. Patent No.(s)						
Additional numbers attached?							
C. Title of Application: LAYERED CHIP PACKAGE AND METHOD OF MANUFACTURING SAME							
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1						
Name: <u>James A. Oliff</u>	7. Please charge Deposit Account No. 15-0461 the total fee (37 CFR 3.41) in the amount of \$40.00.						
Address: OLIFF & BERRIDGE, PLC P.O. Box 320850 Alexandria, VA 22320-4850 Phone Number: 703-836-6400 Fax Number: 703-836-2787	Credit any overpayment or charge any underpayment to deposit account number 15-0461.						
9. Statement and signature. To the best of my knowledge and belief, the foregoing information original document.	on is true and correct and any attached copy is a true copy of the						
James A. Olift Registration No. 27,075 Jay R. Bombien Registration No. 66,569	Date: <u>June 13, 2011</u>						
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ASSIGNMENT (Two Assignees)

		(1)	Yoshitaka SASAKI	(4)	Atsushi IIJI	MA	
(1-8) Insert Name(s) of Inventor(s)	Insert	(2)	Hiroyuki ITO	(5)			
	(3)	Hiroshi IKEJIMA					
		to each	In consideration of the su of the undersigned, each under	ım of one dollar (\$1.00) an		valuable consideration paid ssign, transfer and set over to	
(9A)	Insert Name of First Assignee	(9A)	Headway Technologie	s, Inc.			
(10A)	Insert Address of First Assignee	(10A)	678 S. Hillview Dr., M		S.A.		
(9B)	Insert Name of Second Assignee	(9B)	SAE Magnetics (H.K.) Ltd.				
(10B) Ins	Insert Address of Second Assignee	(10B)	SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science Park, Shat N.T., Hong Kong, CHINA			ong Science Park, Shatin,	
		(hereinafter designated as the Assignee) and Assignee's heirs, successors, assigns and legal representatives, the entire right, title and interest for the United States of America as defined in 35 U.S.C. § 100, in the invention, and in all applications for patent including any and all provisional, non-provisional, divisional, continuation, international, confirmation, substitute and reissue application(s), and all Letters Patent, extensions, reissues and reexamination certificates that may be granted on the invention known as					
•		(11)	LAYERED CHIP PACKA	GE AND METHOD OF M	IANUFACTURI	NG THE SAME	
	such as Title, Case Number or Foreign						
	Application Number	Attorn	ey Docket No.	148406			
			ch the undersigned has (have) ate herewith or	executed an application for	patent in the Ur	ited States of America on	
(12)	Insert Date of Signing of Application	(12)	on				
(13)	Alternative Identification for filed applications	(13)	U.S. Application Serial Nun January 26,		118		
		filed _	dandary 20,	2011			
patents a	 Each undersigned agrees to ons for the invention, and any pats is the Assignees may deem necess Each undersigned agrees to on or continuation or division there 	ent(s) issu ary. execute al	ing thereon, and also to execut l papers necessary in connection	te separate assignments in on with any interference wh	connection with s nich may be decis	ared concerning this	
	in obtaining evidence and going f 3) Each undersigned agrees to	orward w	ith such interference.	_		_ •	
provision	is of the International Convention	for Protect	ction of Industrial Property or s	similar agreements.			
a grant of	4) Each undersigned agrees to p f a valid United States patent to th	e Assigne	ees.				
Patents o	 Each undersigned authorizes f the United States resulting from 	said appl	ication or any divisional, conti	nuing or reissue application	is to the said Ass	ignees, as Assignees of the	
entire int	erest, and covenants that he has funts in conflict herewith, and agree	ıll right to	convey the entire interest here	in assigned, and that he ha	s not executed, a	nd will not execute, any	
	Each undersigned hereby gracecessary or desirable in order to contain the contains and the contains a second contai	ents the fi	m of Oliff & Berridge, pla	C the power to insert on thi	s assignment any	further identification that	
	In witness whereof, executed by					on or this document.	
Date	May 16, 2011	y the uno	Inventor Signature	Site the thinersigned hand	Ž. S	1	
Date _	May 16, 2011			7/1	9 200	(SEAL)	
Date _	May 20, 2011	****	_ Inventor Signature Inventor Signature	W. Colo	ina	(SEAL)	
Date	May 20, 2011		Inventor Signature	Atmbi	Qiià	(SEAL)	
Date _			Inventor Signature			(SEAL)	
Date _			Inventor Signature			(SEAL)	
						,	

This assignment should preferably be signed before: (a) a Notary Public if within the U.S.A. (b) a U.S. Consul if outside the U.S.A. If neither, then it should be signed before at least two witnesses who also sign here:

Date May 16, 2011
May 20, 2011

Witness

PATENT

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